

## N-channel 600 V, 7.3 $\Omega$ typ., 1 A SuperMESH™ Power MOSFET in a DPAK package

Datasheet - production data

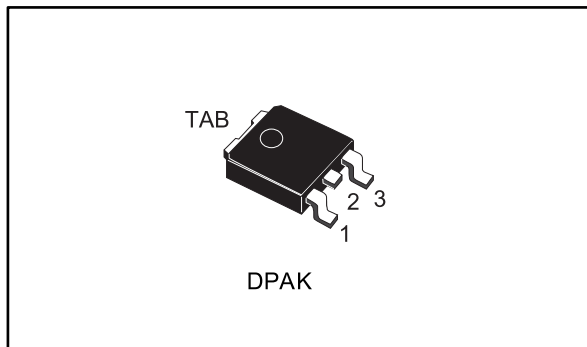
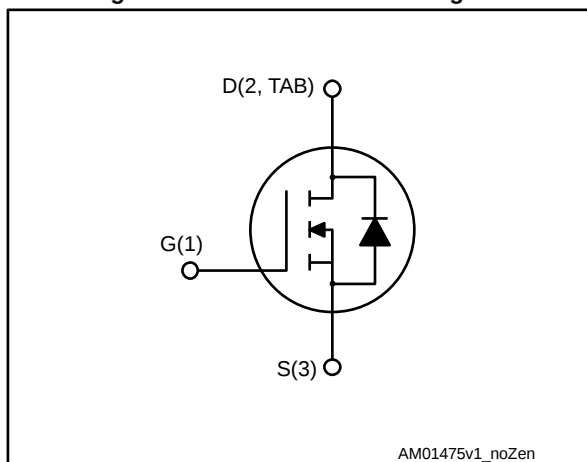


Figure 1: Internal schematic diagram



### Features

| Order code | V <sub>DS</sub> | R <sub>DS(on)</sub> max. | I <sub>D</sub> | P <sub>TOT</sub> |
|------------|-----------------|--------------------------|----------------|------------------|
| STD1NK60T4 | 600 V           | 8.5 $\Omega$             | 1 A            | 30 W             |

- Extremely high dv/dt capability
- ESD improved capability
- 100% avalanche tested
- Gate charge minimized

### Applications

- Low power battery chargers
- Switch mode low power supplies (SMPS)
- Low power, ballast, CFL (compact fluorescent lamps)

### Description

This high voltage device is an N-channel Power MOSFET developed using the SuperMESH™ technology by STMicroelectronics, an optimization of the well-established PowerMESH™. In addition to a significant reduction in on-resistance, this device is designed to ensure a high level of dv/dt capability for the most demanding applications.

Table 1: Device summary

| Order code | Marking | Package | Packing       |
|------------|---------|---------|---------------|
| STD1NK60T4 | D1NK60  | DPAK    | Tape and reel |

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## Contents

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# 1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol         | Parameter                                                                                                            | Value       | Unit             |
|----------------|----------------------------------------------------------------------------------------------------------------------|-------------|------------------|
| $V_{DS}$       | Drain-source voltage                                                                                                 | 600         | V                |
| $V_{DGR}$      | Drain-gate voltage ( $R_{GS} = 20\text{ k}\Omega$ )                                                                  | 600         | V                |
| $V_{GS}$       | Gate-source voltage                                                                                                  | $\pm 30$    | V                |
| $I_D$          | Drain current (continuous) at $T_C = 25\text{ }^\circ\text{C}$                                                       | 1.0         | A                |
| $I_D$          | Drain current (continuous) at $T_C = 100\text{ }^\circ\text{C}$                                                      | 0.63        | A                |
| $I_{DM}^{(1)}$ | Drain current (pulsed)                                                                                               | 4           | A                |
| $P_{TOT}$      | Total dissipation at $T_C = 25\text{ }^\circ\text{C}$                                                                | 30          | W                |
| $I_{AR}$       | Avalanche current, repetitive or not-repetitive (pulse width limited by $T_{jmax}$ )                                 | 1           | A                |
| $E_{AS}$       | Single pulse avalanche energy (starting $T_j = 25\text{ }^\circ\text{C}$ , $I_D = I_{AR}$ , $V_{DD} = 50\text{ V}$ ) | 25          | mJ               |
| $dv/dt^{(2)}$  | Peak diode recovery voltage slope                                                                                    | 3           | V/ns             |
| $T_j$          | Operating junction temperature range                                                                                 | - 55 to 150 | $^\circ\text{C}$ |
| $T_{stg}$      | Storage temperature range                                                                                            |             |                  |

**Notes:**

(1) Pulse width limited by safe operating area.

(2)  $I_{SD} \leq 1.0\text{ A}$ ,  $di/dt \leq 100\text{ A}/\mu\text{s}$ ;  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_j \leq T_{jMAX}$ 

Table 3: Thermal data

| Symbol         | Parameter                           | Value | Unit                      |
|----------------|-------------------------------------|-------|---------------------------|
| $R_{thj-case}$ | Thermal resistance junction-case    | 4.2   | $^\circ\text{C}/\text{W}$ |
| $R_{thj-amb}$  | Thermal resistance junction-ambient | 100   | $^\circ\text{C}/\text{W}$ |

## 2 Electrical characteristics

$T_C = 25\text{ }^{\circ}\text{C}$  unless otherwise specified

**Table 4: On/off-state**

| Symbol        | Parameter                         | Test conditions                                                                                       | Min. | Typ. | Max.      | Unit          |
|---------------|-----------------------------------|-------------------------------------------------------------------------------------------------------|------|------|-----------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage    | $V_{GS} = 0\text{ V}$ , $I_D = 1\text{ mA}$                                                           | 600  |      |           | V             |
| $I_{DSS}$     | Zero gate voltage drain current   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 600\text{ V}$                                                       |      |      | 1         | $\mu\text{A}$ |
|               |                                   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 600\text{ V}$<br>$T_C = 125\text{ }^{\circ}\text{C}$ <sup>(1)</sup> |      |      | 50        | $\mu\text{A}$ |
| $I_{GSS}$     | Gate body leakage current         | $V_{DS}=0\text{ V}$ , $V_{GS}= \pm 30\text{ V}$                                                       |      |      | $\pm 100$ | nA            |
| $V_{GS(th)}$  | Gate threshold voltage            | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                                    | 2.25 | 3    | 3.7       | V             |
| $R_{DS(on)}$  | Static drain-source on-resistance | $V_{GS} = 10\text{ V}$ , $I_D = 0.5\text{ A}$                                                         |      | 7.3  | 8.5       | $\Omega$      |

**Notes:**

<sup>(1)</sup>Defined by design, not subject to production test.

**Table 5: Dynamic**

| Symbol    | Parameter                    | Test conditions                                                                                                                                                 | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $C_{iss}$ | Input capacitance            | $V_{DS} = 25\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GS} = 0\text{ V}$                                                                                             | -    | 156  | -    | pF   |
| $C_{oss}$ | Output capacitance           |                                                                                                                                                                 | -    | 23.5 | -    | pF   |
| $C_{rss}$ | Reverse transfer capacitance |                                                                                                                                                                 | -    | 3.8  | -    | pF   |
| $Q_g$     | Total gate charge            | $V_{DD} = 480\text{ V}$ , $I_D = 1\text{ A}$<br>$V_{GS} = 0\text{ to }10\text{ V}$<br>(see <a href="#">Figure 16: "Test circuit for gate charge behavior"</a> ) | -    | 7    | -    | nC   |
| $Q_{gs}$  | Gate-source charge           |                                                                                                                                                                 | -    | 1.1  | -    | nC   |
| $Q_{gd}$  | Gate-drain charge            |                                                                                                                                                                 | -    | 3.7  | -    | nC   |

**Table 6: Switching times**

| Symbol       | Parameter           | Test conditions                                                                                                                                                                                                                                         | Min. | Typ. | Max. | Unit |
|--------------|---------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 300\text{ V}$ , $I_D = 0.5\text{ A}$ ,<br>$R_G = 4.7\text{ }\Omega$<br>$V_{GS} = 10\text{ V}$<br>(see <a href="#">Figure 15: "Test circuit for resistive load switching times"</a> and <a href="#">Figure 20: "Switching time waveform"</a> ) | -    | 6.5  | -    | ns   |
| $t_r$        | Rise time           |                                                                                                                                                                                                                                                         | -    | 5    | -    | ns   |
| $t_{d(off)}$ | Turn-off delay time |                                                                                                                                                                                                                                                         | -    | 19   | -    | ns   |
| $t_f$        | Fall time           |                                                                                                                                                                                                                                                         | -    | 25   | -    | ns   |

Table 7: Source-drain diode

| Symbol          | Parameter                     | Test conditions                                                                                                                                                                                                                            | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $I_{SD}$        | Source-drain current          |                                                                                                                                                                                                                                            | -    |      | 1    | A    |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |                                                                                                                                                                                                                                            | -    |      | 4    | A    |
| $V_{SD}^{(2)}$  | Forward on voltage            | $I_{SD} = 1.0 \text{ A}$ , $V_{GS} = 0 \text{ V}$                                                                                                                                                                                          | -    |      | 1.6  | V    |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 1.0 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 25 \text{ V}$ ,<br>(see <a href="#">Figure 17: "Test circuit for inductive load switching and diode recovery times"</a> )                                    | -    | 140  |      | ns   |
| $Q_{rr}$        | Reverse recovery charge       |                                                                                                                                                                                                                                            | -    | 240  |      | nC   |
| $I_{RRM}$       | Reverse recovery current      |                                                                                                                                                                                                                                            | -    | 3.3  |      | A    |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 1.0 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 25 \text{ V}$ , $T_j = 150 \text{ }^\circ\text{C}$<br>(see <a href="#">Figure 17: "Test circuit for inductive load switching and diode recovery times"</a> ) | -    | 229  |      | ns   |
| $Q_{rr}$        | Reverse recovery charge       |                                                                                                                                                                                                                                            | -    | 377  |      | nC   |
| $I_{RRM}$       | Reverse recovery current      |                                                                                                                                                                                                                                            | -    | 3.3  |      | A    |

**Notes:**

<sup>(1)</sup>Pulse width limited by safe operating area

<sup>(2)</sup>Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

Figure 2: Safe operating area

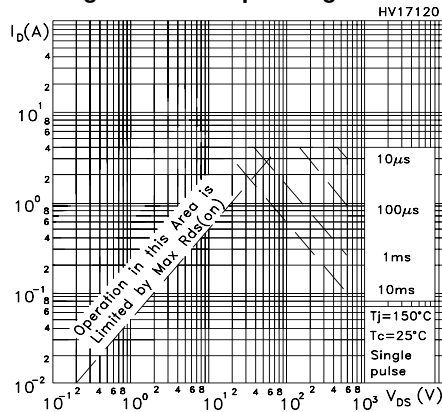


Figure 3: Thermal impedance

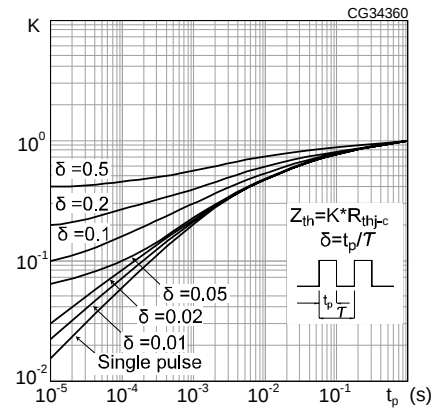


Figure 4: Output characteristics

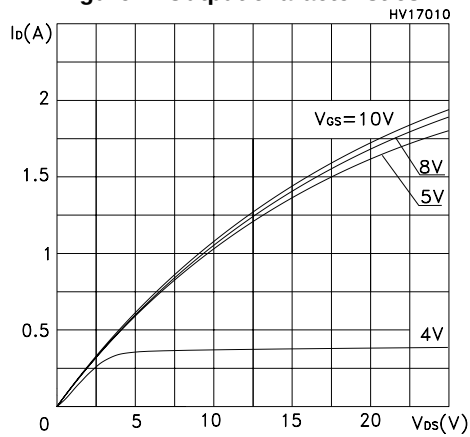


Figure 5: Transfer characteristics

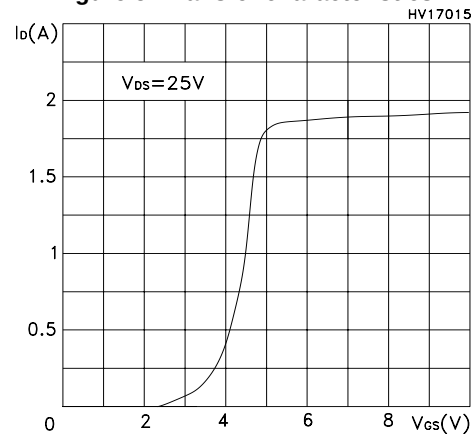


Figure 6: Gate charge vs gate-source voltage

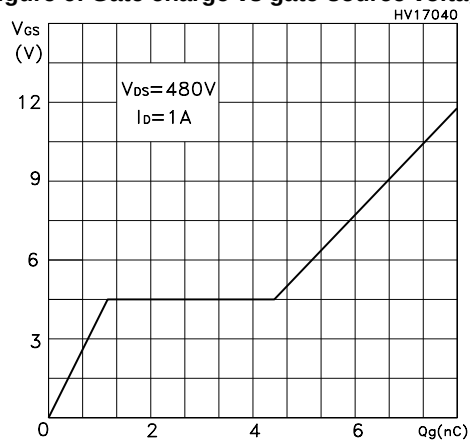


Figure 7: Capacitance variations

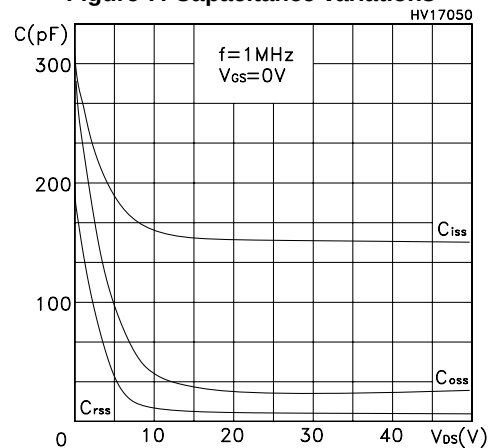


Figure 8: Static drain-source on-resistance

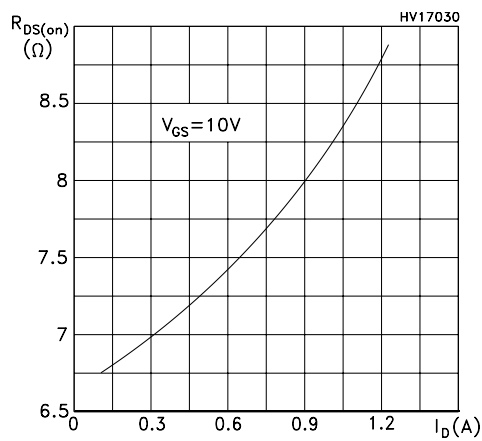


Figure 9: Normalized gate threshold voltage vs temperature

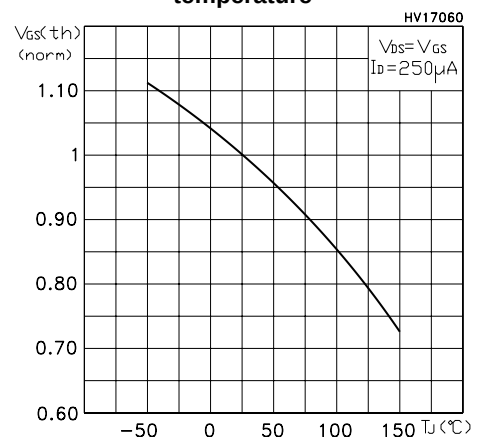


Figure 10: Normalized on-resistance vs temperature

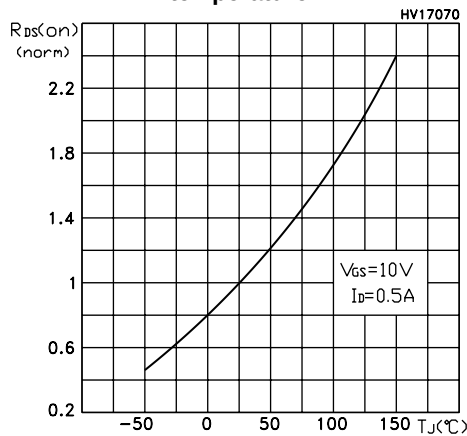


Figure 11: Source-drain forward characteristics

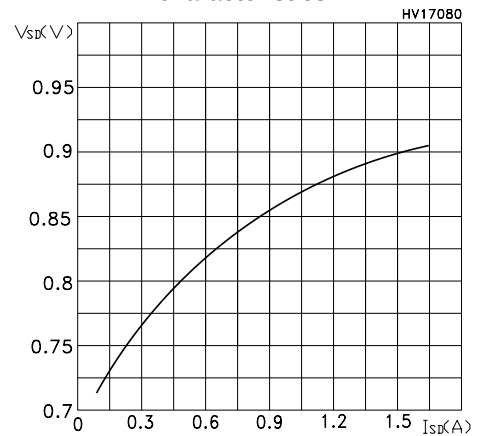
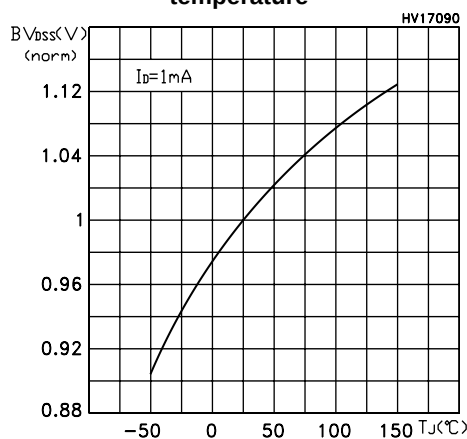
Figure 12: Normalized  $V_{(BR)DSS}$  vs temperature

Figure 13: Maximum avalanche energy vs temperature

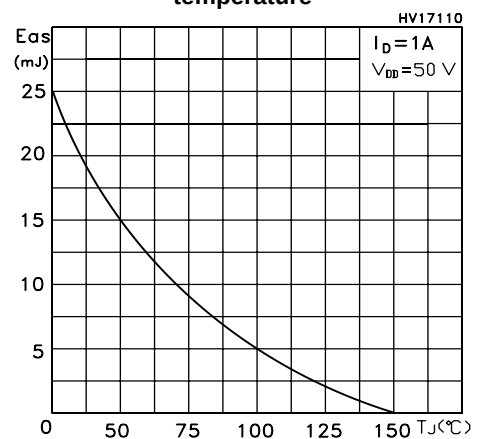
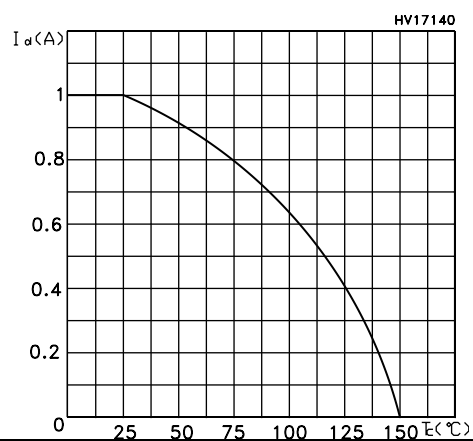
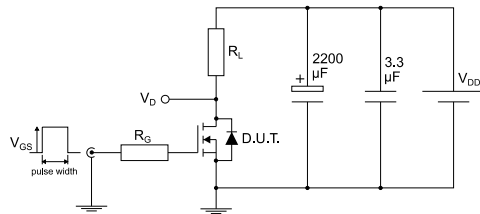


Figure 14: Maximum  $I_d$  current vs  $T_c$ 

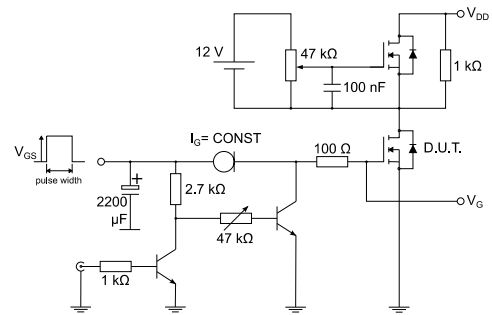
### 3 Test circuits

**Figure 15: Test circuit for resistive load switching times**



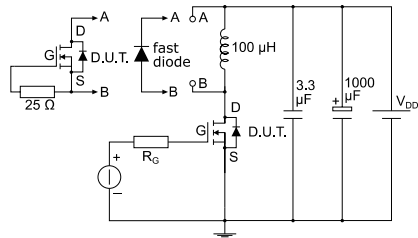
AM01468v1

**Figure 16: Test circuit for gate charge behavior**



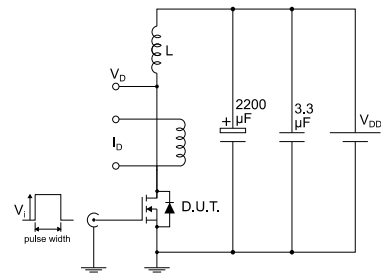
AM01469v1

**Figure 17: Test circuit for inductive load switching and diode recovery times**



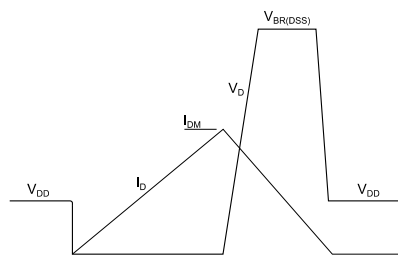
AM01470v1

**Figure 18: Unclamped inductive load test circuit**



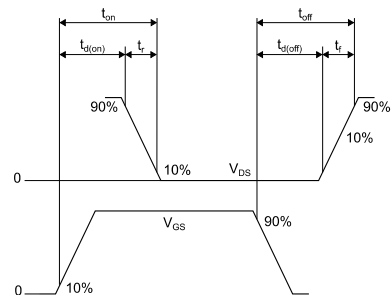
AM01471v1

**Figure 19: Unclamped inductive waveform**



AM01472v1

**Figure 20: Switching time waveform**



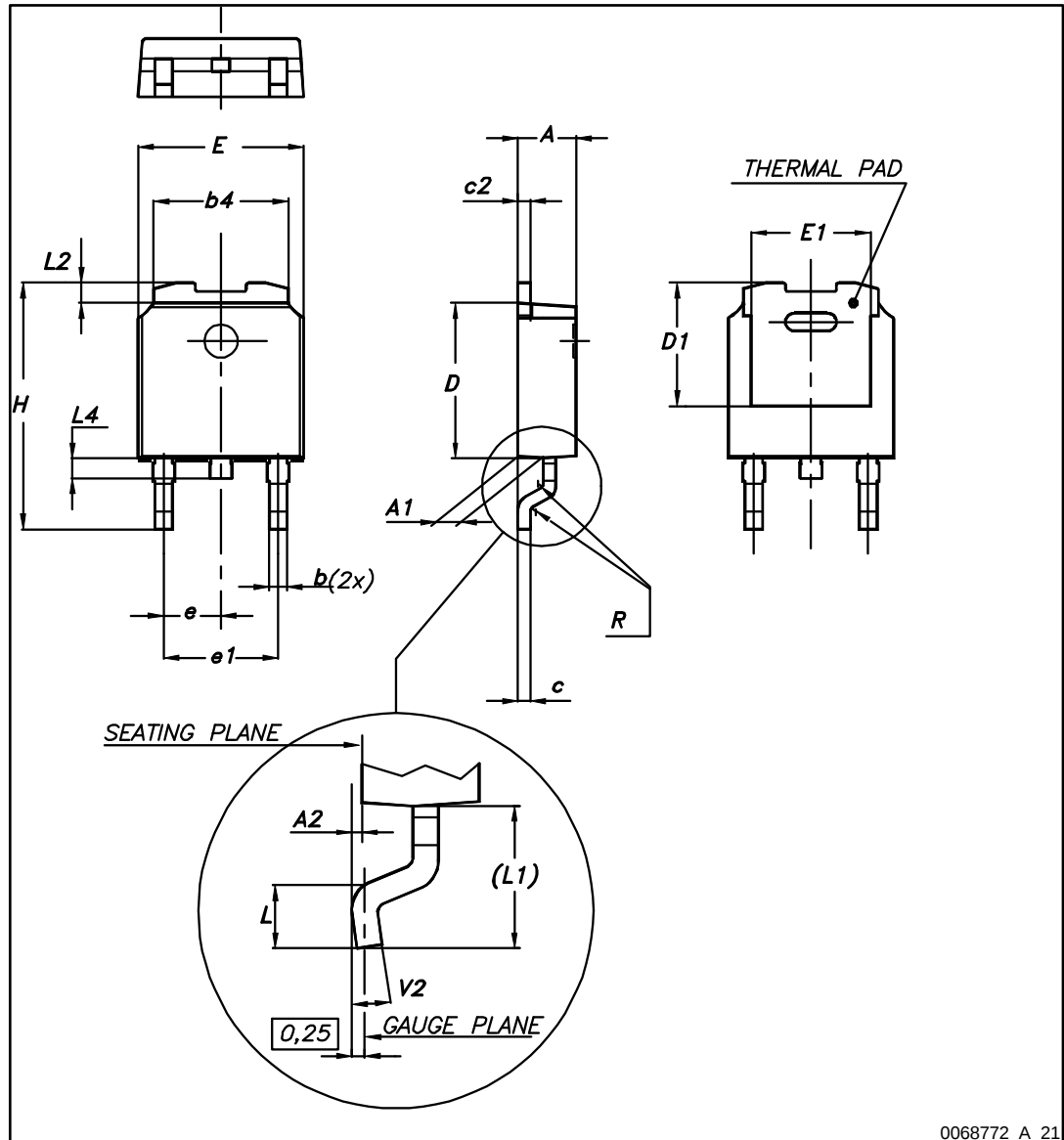
AM01473v1

## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

### 4.1 DPAK (TO-252) type A package information

Figure 21: DPAK (TO-252) type A package outline

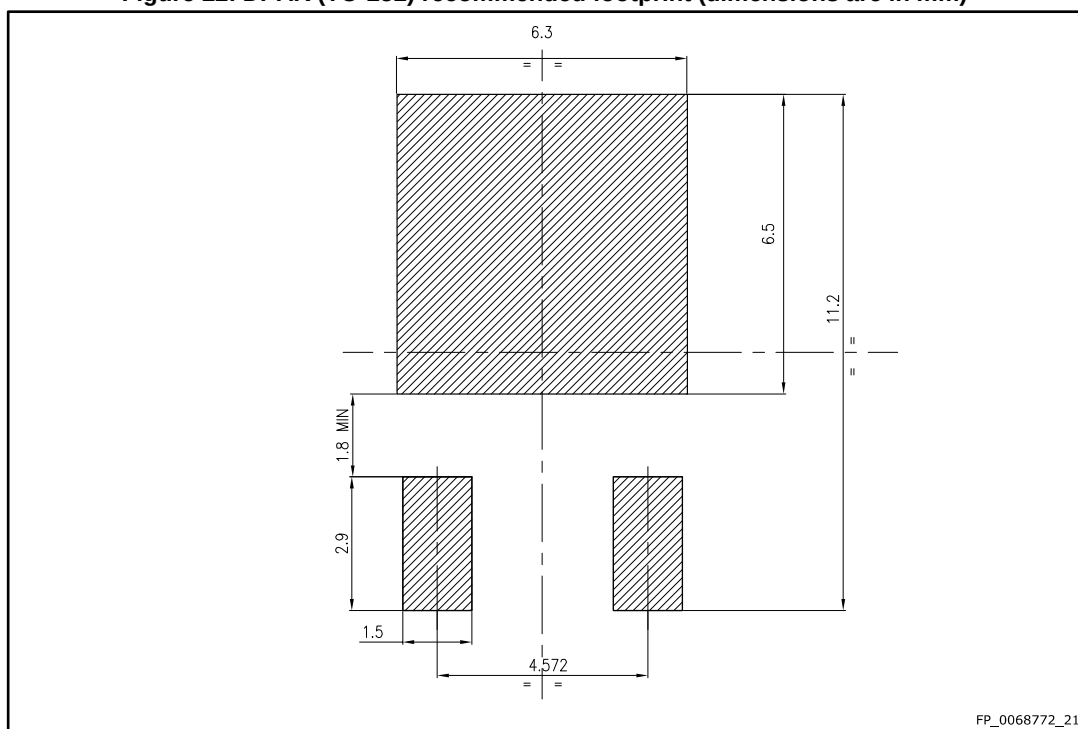


0068772\_A\_21

Table 8: DPAK (TO-252) type A mechanical data

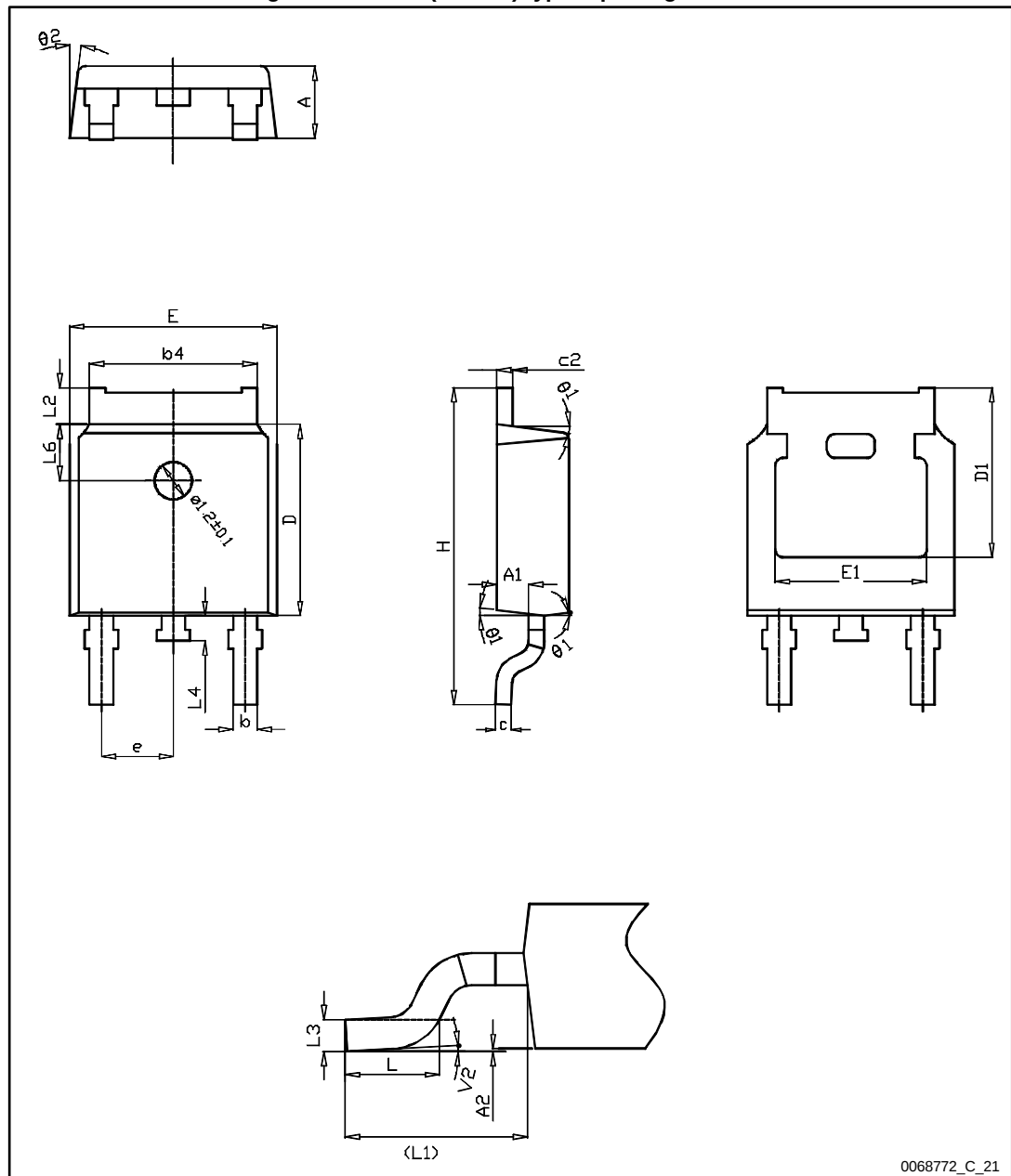
| Dim. | mm   |      |       |
|------|------|------|-------|
|      | Min. | Typ. | Max.  |
| A    | 2.20 |      | 2.40  |
| A1   | 0.90 |      | 1.10  |
| A2   | 0.03 |      | 0.23  |
| b    | 0.64 |      | 0.90  |
| b4   | 5.20 |      | 5.40  |
| c    | 0.45 |      | 0.60  |
| c2   | 0.48 |      | 0.60  |
| D    | 6.00 |      | 6.20  |
| D1   | 4.95 | 5.10 | 5.25  |
| E    | 6.40 |      | 6.60  |
| E1   | 4.60 | 4.70 | 4.80  |
| e    | 2.16 | 2.28 | 2.40  |
| e1   | 4.40 |      | 4.60  |
| H    | 9.35 |      | 10.10 |
| L    | 1.00 |      | 1.50  |
| (L1) | 2.60 | 2.80 | 3.00  |
| L2   | 0.65 | 0.80 | 0.95  |
| L4   | 0.60 |      | 1.00  |
| R    |      | 0.20 |       |
| V2   | 0°   |      | 8°    |

Figure 22: DPAK (TO-252) recommended footprint (dimensions are in mm)



## 4.2 DPAK (TO-252) type C package information

Figure 23: DPAK (TO-252) type C package outline

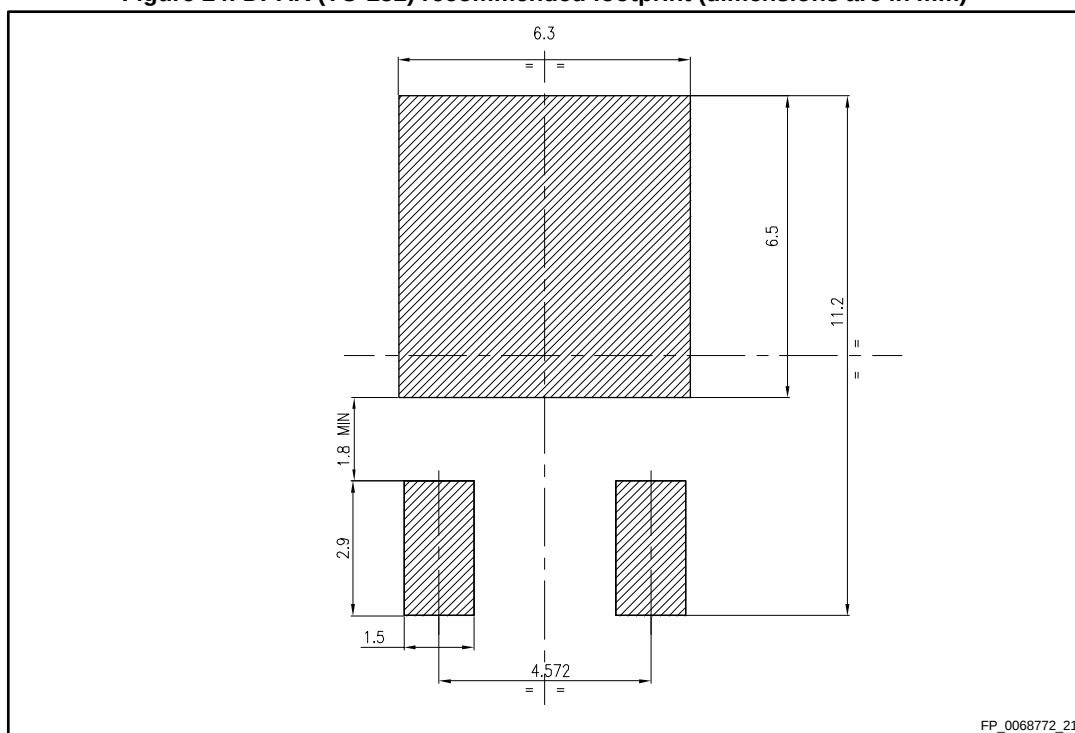


0068772\_C\_21

Table 9: DPAK (TO-252) type C mechanical data

| Dim. | mm       |       |       |
|------|----------|-------|-------|
|      | Min.     | Typ.  | Max.  |
| A    | 2.20     | 2.30  | 2.38  |
| A1   | 0.90     | 1.01  | 1.10  |
| A2   | 0.00     |       | 0.10  |
| b    | 0.72     |       | 0.85  |
| b4   | 5.13     | 5.33  | 5.46  |
| c    | 0.47     |       | 0.60  |
| c2   | 0.47     |       | 0.60  |
| D    | 6.00     | 6.10  | 6.20  |
| D1   | 5.25     |       |       |
| E    | 6.50     | 6.60  | 6.70  |
| E1   | 4.70     |       |       |
| e    | 2.186    | 2.286 | 2.386 |
| H    | 9.80     | 10.10 | 10.40 |
| L    | 1.40     | 1.50  | 1.70  |
| L1   | 2.90 REF |       |       |
| L2   | 0.90     |       | 1.25  |
| L3   | 0.51 BSC |       |       |
| L4   | 0.60     | 0.80  | 1.00  |
| L6   | 1.80 BSC |       |       |
| θ1   | 5°       | 7°    | 9°    |
| θ2   | 5°       | 7°    | 9°    |
| V2   | 0°       |       | 8°    |

Figure 24: DPAK (TO-252) recommended footprint (dimensions are in mm)



### 4.3 Packing information

Figure 25: DPAK (TO-252) tape outline

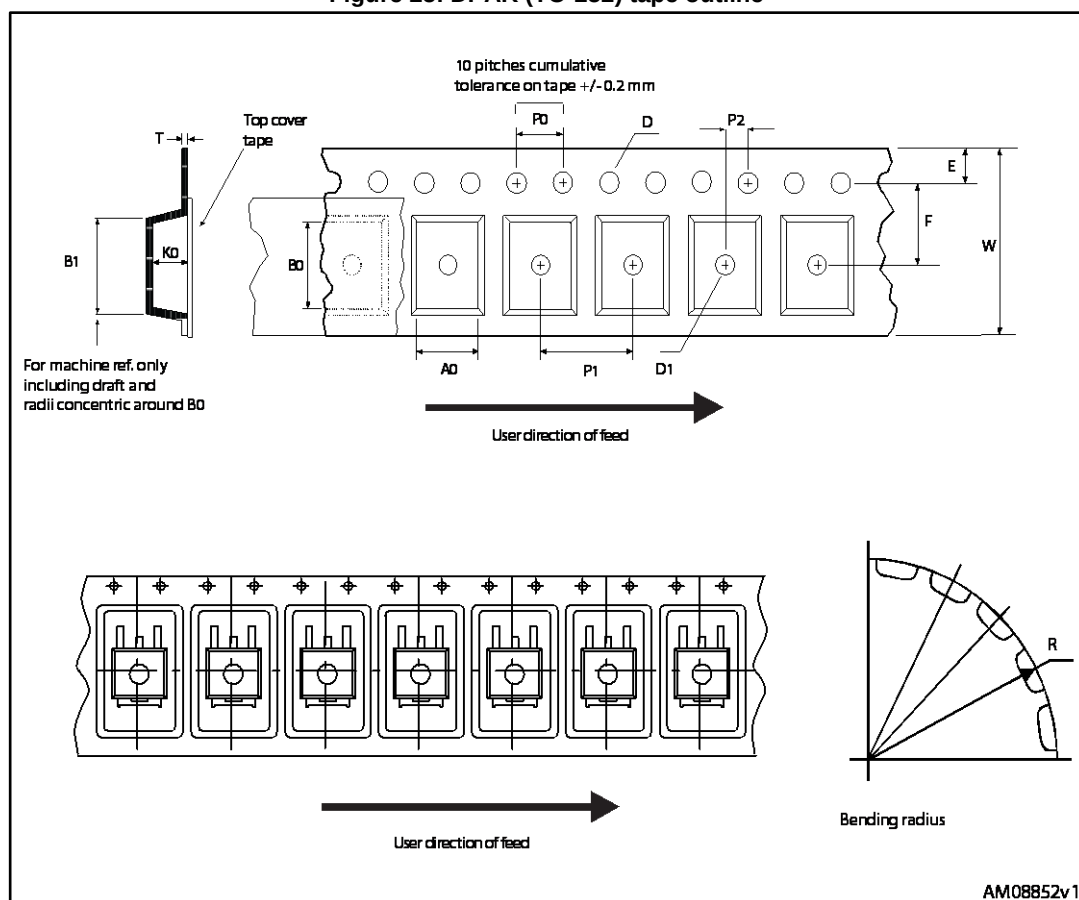


Figure 26: DPAK (TO-252) reel outline

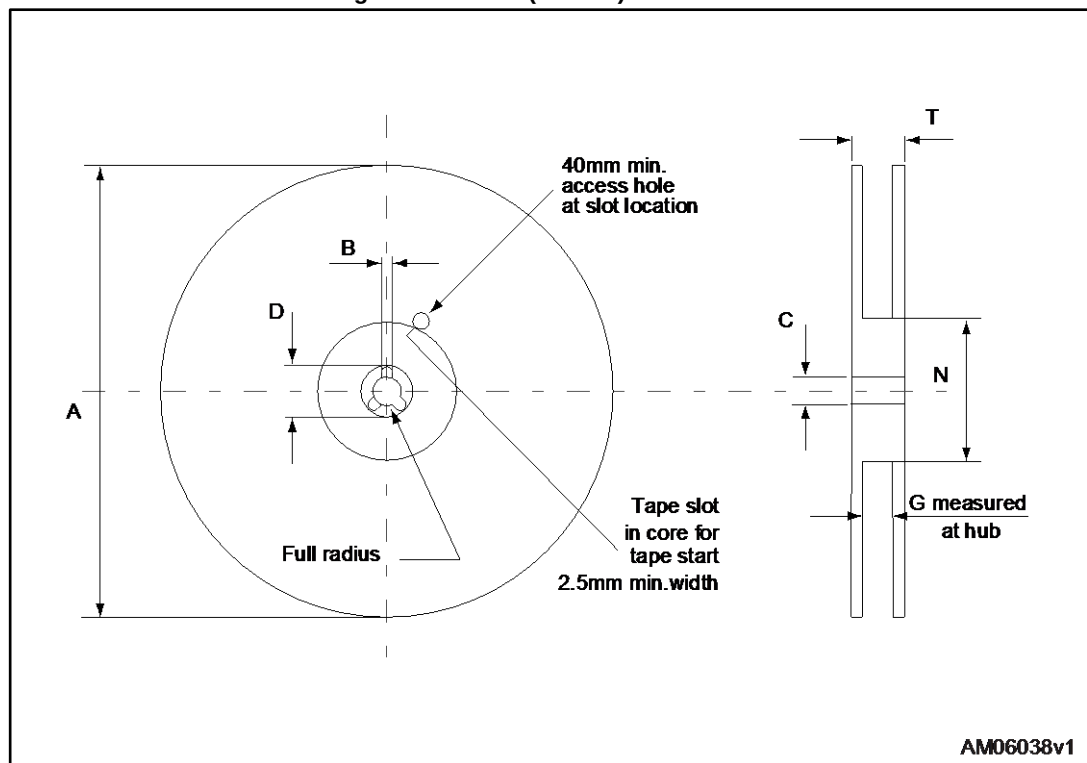


Table 10: DPAK (TO-252) tape and reel mechanical data

| Tape |      |      | Reel      |      |      |
|------|------|------|-----------|------|------|
| Dim. | mm   |      | Dim.      | mm   |      |
|      | Min. | Max. |           | Min. | Max. |
| A0   | 6.8  | 7    | A         |      | 330  |
| B0   | 10.4 | 10.6 | B         | 1.5  |      |
| B1   |      | 12.1 | C         | 12.8 | 13.2 |
| D    | 1.5  | 1.6  | D         | 20.2 |      |
| D1   | 1.5  |      | G         | 16.4 | 18.4 |
| E    | 1.65 | 1.85 | N         | 50   |      |
| F    | 7.4  | 7.6  | T         |      | 22.4 |
| K0   | 2.55 | 2.75 |           |      |      |
| P0   | 3.9  | 4.1  | Base qty. |      | 2500 |
| P1   | 7.9  | 8.1  | Bulk qty. |      | 2500 |
| P2   | 1.9  | 2.1  |           |      |      |
| R    | 40   |      |           |      |      |
| T    | 0.25 | 0.35 |           |      |      |
| W    | 15.7 | 16.3 |           |      |      |

## 5 Revision history

Table 11: Document revision history

| Date        | Revision | Changes        |
|-------------|----------|----------------|
| 06-Feb-2017 | 1        | First release. |

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